

HUAJING**ST600C...SERIES****DISC TYPE THYRISTOR****Features**

- Metal case with ceramic insulator
- All diffused design, Center amplifying gate
- High surge current capabilities
- Guaranteed high dv/dt
- Guaranteed high di/dt
- Low thermal impedance
- High speed performance

600A**Typical Applications**

- DC Motor control, AC controllers
- Controlled DC power supplies

Major Ratings and Characteristics

Parameters	ST600C	Units
$I_{T(AV)}$	600	A
	@ T_{hs}	°C
$I_{T(RMS)}$	942	A
	@ T_{hs}	°C
I_{TSM}	@ 50Hz	A
	@ 60Hz	A
I^2t	@ 50Hz	KA ² s
	@ 60Hz	KA ² s
V_{DRM} / V_{RRM}	1800	V
T_q typical	150	μs
T_J range	- 40 to 125	°C

HUAJING**ST600C...SERIES****ELECTRICAL SPECIFICATIONS****Voltage Ratings**

Type number	Voltage Code	V_{RRM} , maximum repetitive peak reverse voltage V	V_{RSM} , maximum non-repetitive peak rev. voltage V	I_{DRM}/I_{RRM} max. @ $T_J = T_J$ max. mA
ST600C	04	400	500	40
	08	800	900	
	12	1200	1300	
	18	1800	1900	

On-state Conduction

Parameter	ST600C	Units	Conditions			
$I_{T(AV)}$ Maximum average on-state current @ Heatsink temperature	600	A	180° conduction, half sine wave			
	65	°C			Double side cooled	
$I_{(RMS)}$ Maximum RMS on-state current	942	A	DC@ 25°C heatsink temperature double side cooled			
I_{TSM} , Maximum peak, one-cycle non-repetitive surge current	9000	A	$t = 10ms$	No voltage	Sinusoidal half wave, Initial $T = T$ max.	
	9420		$t = 8.3ms$	reapplied		
	7570		$t = 10ms$	100% V_{RRM}		
	7920		$t = 8.3ms$	reapplied		
$I^2 t$ Maximum $I^2 t$ for fusing	405	KA ² s	$t = 10ms$	No voltage		
	370		$t = 8.3ms$	reapplied		
	287		$t = 10ms$	100% V_{RRM}		
	262		$t = 8.3ms$	reapplied		
$I^2 \sqrt{t}$ Maximum $I^2 \sqrt{t}$ for fusing	4050	KA ² √ s	$t = 0.1$ to 10ms, no voltage reapplied			
V_{TM} Max. peak on-state voltage	1.95	V	$I_{TM} = 1884A$, $T_J = T_J$ max, $t_p = 10ms$ sine wave pulse			
I_H Maximum holding current	600	mA	$T_J = 25^\circ C$, $I_t > 30A$			
I_L Typical latching current	1000		$T_J = 25^\circ C$, $V_A = 12V$, $R_a = 6\Omega$, $I_g = 1A$			

Switching

Parameter	ST600C	Units	Conditions	
di/dt Maximum non repetitive rate of rise of turned-on current	1000	A/μs	$T_J = T_J$ max, V_{DRM} = rated V_{DRM}	$I_{TM} = 2 \times di/dt$
t_d Typical delay time	1.1	μs	$T_J = 25^\circ C$, V_{DM} = rated V_{DRM} , $I_{TM} = 50A$ DC, $t_p = 1\mu s$ Resistive load Gate pulse: 10V, 5Ω source	
T_q Max. turn-off time (*)	Min 100 Max 200			
			$T_J = T_J$ max, $I_{TM} = 50A$ DC, $di/dt = 40A/\mu s$, $V_R = 50V$, $t_p = 500\mu s$, dv/dt : see table in device code	

Blocking

Parameter	ST600C	Units	Conditions
dv/dt Maximum critical rate of rise of off-state voltage	500	V/ μ s	T _J = T _J max. linear to 80% V _{DRM} , higher value available on request
I _{DRM} Max. peak reverse and off-state leakage current	40	mA	T _J = T _J max, rated V _{DRM} /V _{RRM} applied

Triggering

Parameter	ST600C	Units	Conditions
P _{GM} Maximum peak gate power	10	W	T _J = T _J max, f = 50Hz, d% = 50
P _{G(AV)} Maximum average gate power	2		
I _{GM} Max. peak positive gate current	3	A	T _J = T _J max, t _p ≤ 5ms
+V _{GM} Maximum peak positive gate voltage	20		
-V _{GM} Maximum peak negative gate voltage	5.0	V	T _J = T _J max, t _p ≤ 5ms
I _{GT} DC gate current required to trigger	200		
V _{GT} DC gate voltage required to trigger	3	mA	T _J = 25°C, V _A = 12V, R _a = 6Ω
I _{GD} DC gate current not to trigger	10		
V _{GD} DC gate voltage not to trigger	0.25	V	T _J = T _J max, rated V _{DRM} applied

Thermal and Mechanical Specification

Parameter	ST600C	Units	Conditions
T _J Max. operating temperature range	-40 to 125	°C	
T _{stg} Max. storage temperature range	-40 to 150		
R _{thJ-hs} Max. thermal resistance, junction to case	0.09 0.04	K/W	DC operation single side cooled DC operation double side cooled
R _{thC-hs} Max. thermal resistance, case to heatsink	0.02 0.01		DC operation single side cooled DC operation double side cooled
T Mounting torque, ± 10%	10	KN	
wt Approximate weight	90	g	

Outline Table in MM

